

Electronic Information Products Pollution Control key management directory (first batch)

Catalogue Entry Number	Electronic Information Products Category	Customs HS codes	Restrictions on the use of toxic and hazardous substances or elements	Temporary exemptions (wt% as a weight percentage of content)	Restrictions implementation timing
1	Mobile user terminal	85171210	Lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, polybrominated diphenyl ethers and other substances or element content consistent with standard SJ/T11363-2006.	<ol style="list-style-type: none"> 1) Lead used in electronic components, glass; 2) Lead and cadmium used in optical glass and filter glass; 3) Lead used in electronic components, ceramic; 4) Lead alloy used in steel as an alloying element where its content is less than or equal to 0.35wt%; 5) Lead as an alloying element used in aluminium alloy where its content is less than or equal to 0.4wt%; 6) Lead as an alloying element used in copper alloy where its content is less than or equal to 4.0wt%; 7) Lead used in high temperature solder, where its content is not less than 85wt%; 8) Lead applied to solder used in microprocessor package and pins, where its content is 80-85wt%; 9) Lead applied to the internal bonding solder used in flip-chip package integrated circuits; 10) Lead applied to the surface finish of fine pitch iron-nickel or copper component lead-frames (excluding connectors) where the pitch is no more than 0.65mm. 	Ten months after official adoption of this category

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2	Telephone (including fixed and cordless terminals)	85171100 85171800	Lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, polybrominated diphenyl ethers and other substances or element content consistent with standard SJ/T11363-2006.	<ol style="list-style-type: none"> 1) Lead used in electronic components, glass; 2) Lead and cadmium used in optical glass and filter glass; 3) Lead used in electronic components, ceramic; 4) Lead alloy used in steel as an alloying element where its content is less than or equal to 0.35wt%; 5) Lead as an alloying element used in aluminium alloy where its content is less than or equal to 0.4wt%; 6) Lead as an alloying element used in copper alloy where its content is less than or equal to 4.0wt%; 7) Lead used in high temperature solder, where its content is not less than 85wt%; 8) Lead applied to solder used in microprocessor package and pins, where its content is 80-85wt%; 9) Lead applied to the internal bonding solder used in flip-chip package integrated circuits; 10) Lead applied to the surface finish of fine pitch iron-nickel or copper component lead-frames (excluding connectors) where the pitch is no more than 0.65mm. 	Ten months after official adoption of this category

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Catalogue Entry Number	Electronic Information Products Category	Customs HS codes	Restrictions on the use of toxic and hazardous substances or elements	Exemptions	Restrictions implementation timing
3	Printer devices connected to a computer	84433211 84433212 84433213 84433214 84433219	Lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, polybrominated diphenyl ethers and other substances or element content consistent with standard SJ/T11363-2006.	<ol style="list-style-type: none"> 1) Lead used in electronic components, glass; 2) Lead and cadmium used in optical glass and filter glass; 3) Lead used in electronic components, ceramic; 4) Lead alloy used in steel as an alloying element where its content is less than or equal to 0.35wt%; 5) Lead as an alloying element used in aluminium alloy where its content is less than or equal to 0.4wt%; 6) Lead as an alloying element used in copper alloy where its content is less than or equal to 4.0wt%; 7) Lead used in high temperature solder, where its content is not less than 85wt%; 8) Lead applied to solder used in microprocessor package and pins, where its content is 80-85wt%; 	Ten months after official adoption of this category

Attachment: Electronic Information Products Pollution Control key management directory (first batch) definitions of scope of product categories

Product Category 1: Mobile User Terminal

Definition:

As used for social services and public use of public mobile communication network to achieve communication with GSM (TDMA), CDMA, TD-SCDMA, WCDMA, and CDMA2000 cellular mobile terminal equipment

Product Examples:

GSM (900/1800MHz TDMA) digital cellular mobile phones, CDMA (800MHz) digital cellular mobile phones, TD-SCDMA (2GHz) digital cellular mobile phones, WCDMA (2GHz) digital cellular mobile phones, CDMA2000 (2GHz) digital cellular mobile telephone; car mobile phone over the network using standard wireless data cards; cell phones and other devices using the PHS network signal.

Product Category 2: Telephone (including fixed and cordless telephone terminals)

Definitions:

Fixed telephone terminal - for use on the PSTN network and within offices, with direct wired connection to the end users line

Cordless telephone terminal - for use on the PSTN network via a landline (or local host) with the cable subscriber line connected to the phone terminal using wireless communication, where the portable phone can remotely access the same bell, dial-up and call functions of fixed telecommunications terminal products.

Product Examples:

Fixed telephone terminal - ordinary telephone, Caller ID phone, card management telephone, recording telephone, payphone, smart card telephone, IC-Card payphone machine, hands-free telephone, digital telephone, smart phone and other messaging devices.

Cordless telephone terminal - analogue cordless phones, 2.4GHz digital cordless phones and so on.

Product Category 3: Printer devices connected to a computer

Definition:

Device used to print documents, notes or pictures with a computer connected to the communication interface, used alone or with other IT devices.

Product Examples:

Laser printer, dot matrix printer, inkjet printer, thermal printer, thermal transfer printer, receipt printer, label printer, bar code printer.